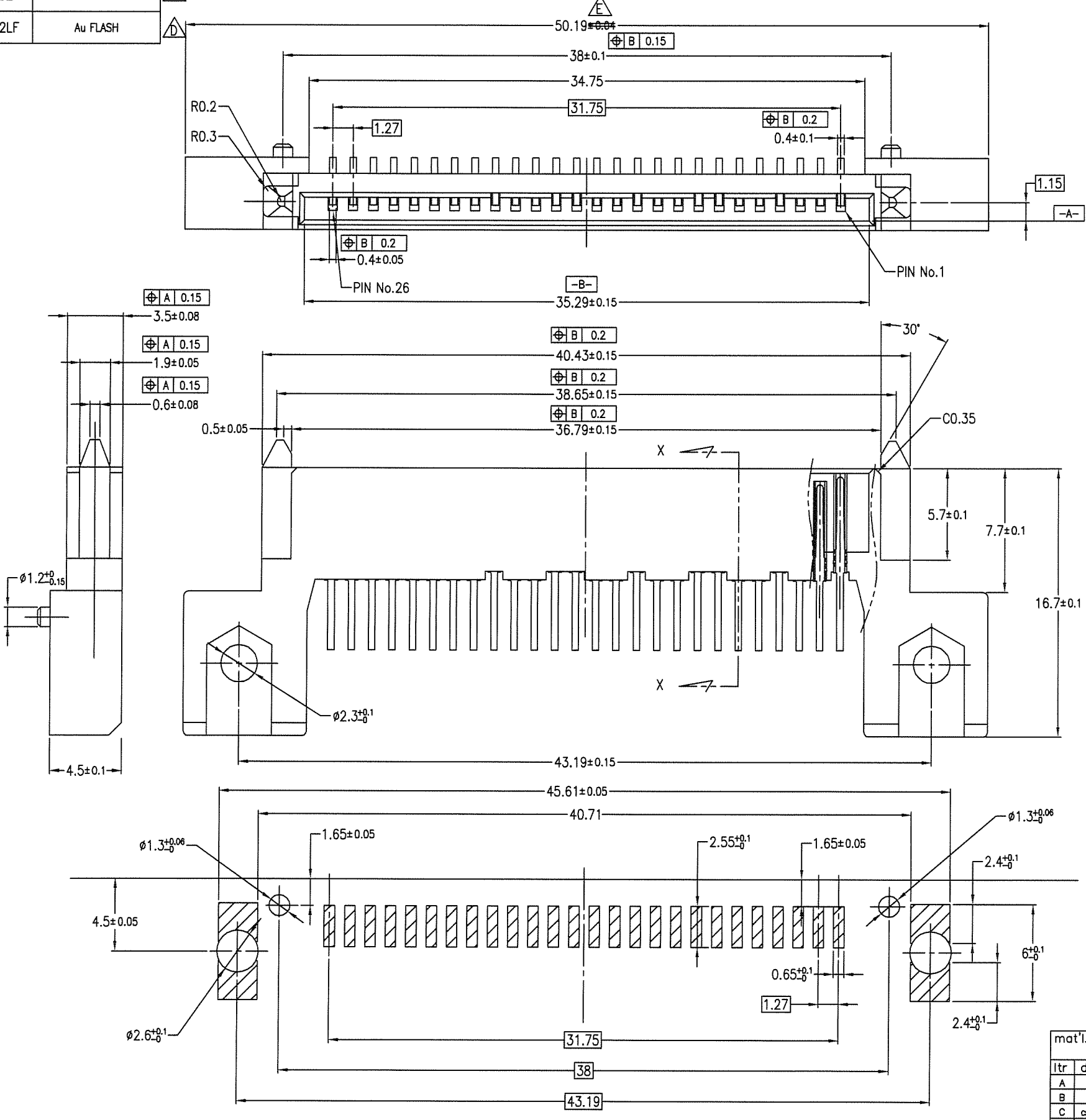
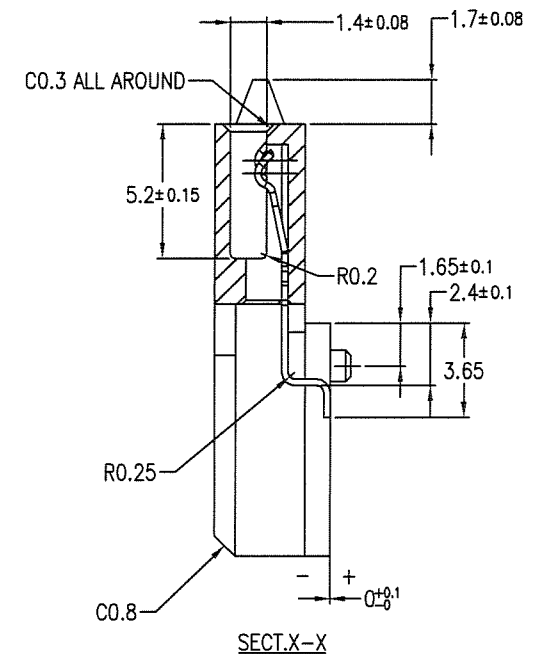


PRODUCT NO.	FINISH : Solder Tail
10033998-001	Pure Sn 1.27μm MIN.
10033998-002	Au FLASH
10033998-002LF	Au FLASH



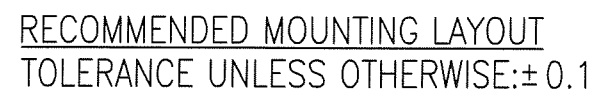
RECOMMENDED MOUNTING LAYOUT
TOLERANCE UNLESS OTHERWISE: ±0.1



NOTE
1. THIS PRODUCT MEETS THE IVDR-HWSPEC (2.5-inch, 1.8-inch Serial type)
2. MATERIAL
1) HOUSING : HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0
2) TERMINAL : COPPER ALLOY
3. FINISH
1) TERMINAL : ALL OVER Ni 1.27μm MIN.
CONTACT POINT Au PLATING 0.3μm MIN.
SOLDER TAIL SEE TABLE
4. RoHS
THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER
COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008

mat'l. code				surface	tolerance	projection	product family	CODE
---				ISO 1302	ISO 1101	MM	55SF Removable HDD	JP
ltr	description	ecn no	dr	date	tolerances unless otherwise specified	linear	title	
A	RELEASED	J04-0286	Y.K	8/23/04	0.X	±0.3	ASSEMBLY	
B	REVISED	J05-0107	Y.K	2/24/05	0.XX	±0.3	S-IVDR COMB RECE.	
C	Change DWG form	J07-0041	Y.K	1/23/07	0.XXX	±0.3	SMT R/A TYPE	
D	Change of P/N	J07-0464	Y.K	2007-9-13	dr	Y.KAMEDA	2008-11-28	dwg no
E	Change of P/N	J08-0253	Y.K	2008-6-12	enrgr	Y.KAMEDA	2009-11-28	sheet 1 of 2 size
F	Add sheet2	J09-0416	Y.K	2008-6-12	chr	8.2.2.2	2009-11-27	10033998
sheet index				revision	F	F	type	Product Customer Drawing
				sheet	1	2		Rev. F

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SECT.X-X

SECT.Y-Y

COUNTRY REGULATIONSAS DESCRIBED IN GS-22-008

mat'l. code ---					surface ISO 1302 ✓		tolerance ISO 406 ISO 1101		projection 		product family 55SF Removable HDD			CODE JP						
ltr		description		ecn no		dr		date		tolerances unless otherwise specified		title								
F		RELEASED		J09-0416		Y.K		2009-11-28		angles linear		0.X ±0.3 0.XX ±0.3 0.XXX ±0.3		 scale 5:1		ASSEMBLY S-IVDR COMB RECE. SMT R/A TYPE				
										dr Y.KAMEDA 2009-11-28 enr Y.KAMEDA 2009-11-28 chr A. Ishikawa 2009-11-27 appd M. Imai Nov 27 09				dwg no 10033998		sheet 2 of 2		size A2		
sheet index		revision sheet														type Product Customer Drawing		Rev. F		